

Simon Fidder
Att. Mr. R. Faure
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Our ref: ESA-TECMSP-LE-2026-003286

VISA: T.Rohr (TEC-MSP)


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by Thomas Rohr
Date: 2026.10.16
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Noordwijk, 13/10/2026

SUBJECT: QUALIFICATION RENEWAL OF NON SEQUENTIAL RIGID-FLEX EPOXY PCB

Systronic submitted a non-sequential rigid flex Epoxy HTg PCB for qualification renewal in July 2026. The qualification results are reported in ESA-TECMSP-TR-2026-003043. No Deviations from the applicable requirements were identified during the inspection of the qualification board.

Systronic is therefore considered qualified in accordance with ECSS-Q-ST-70-60C for the manufacture of printed circuit boards within the qualification domain defined by the following Process Identification Document (PID).

- Non sequential rigid-flex epoxy HTg PCB as defined in PID4 edition 13, until 30 October 2028.

Kind regards,

Simon
Fidder


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Simon Fidder
Material, Manufacturing and Assembly section TEC-MSP